

### **Features**

- High reliability
- General purpose leads
- Peak wavelength λp=880nm
- Mechanically and spectrally matched to the phototransistor
- Low forward voltage
- High radiant intensity

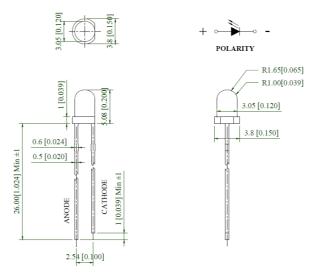
## **Applications**

- Optoelectronic Switch
- IR Touch-Panel
- Industrial IR Equipment
- Consumer Electronics
- High Speed IR Communications

### **Description**

- The infrared emitting diode (880nm) is a high intensity diode, molded in a blue transparent plastic package.
- The device is spectrally matched with silicon photodiode and phototransistor.

### Package Dimensions in mm



#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm$  0.25 mm (.010  $^{\prime\prime}$  ) unless otherwise noted.

Figure 1. INL-3ABCMIR40 Package Dimensions



## Absolute Maximum Rating at 25°C (Note 1)

Product	Emission Color	P <sub>d</sub> (mW)	I <sub>F</sub> (mA)	I <sub>FP</sub> * (A)	V <sub>R</sub> (V)	T <sub>OP</sub> (°C)	T <sub>ST</sub> (°C)
INL-3ABCMIR40	Infrared	160	100	1	5	-40°C~+80°C	-40°C~+85°C

#### **Notes**

### **Electrical Characteristics** $T_A = 25\%$ (Note 1)

		Emission		V <sub>F</sub> (V)		λ(nm)			Viewing Angle	Ee(mW/sr)	
	Product	Color	I <sub>F</sub> (mA)	min	max	$\lambda_{D}$	$\lambda_{P}$	Δλ	2 0 1/2	min	typ.
	INL-3ABCMIR40	Infrared	20	1.0	1.6	-	880	45	40	8	10

#### Notes

1. Performance guaranteed only under conditions listed in above tables.

#### **ESD Precaution**

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

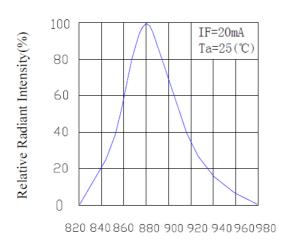
Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

<sup>1.</sup> Condition for IFP is pulse of 1/10 duty and 1kHz frequency



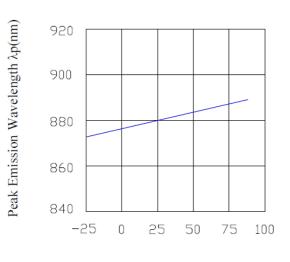
## **Typical Characteristic Curves**

### Spectral Distribution



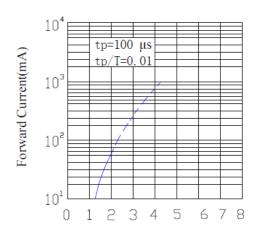
Wavelength  $\lambda(nm)$ 

# Peak Emission Wavelength & Ambient Temperature



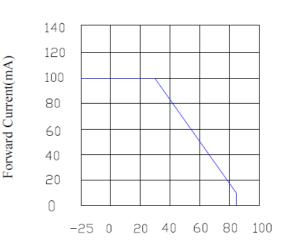
Ambient Temperature(°C)

# Forward Current & Forward Voltage



Forward Voltage(V)

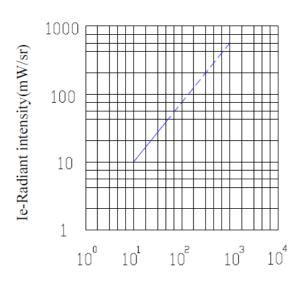
# Forward Current & Ambient Temperature



Ambient Temperature(℃)

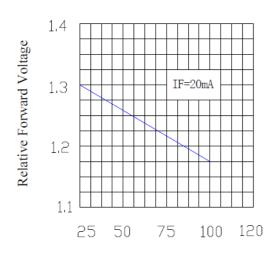


# Relative Intensity & Forward Current



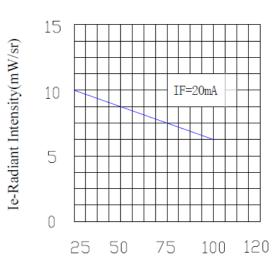
IF-Forward Current(mA)

Forward Voltage & Ambient Temperature(°C)



Ambient Temperature (°C)

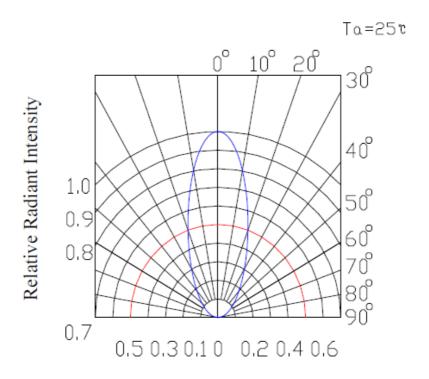
Relative Intensity & Ambient Temperature( $^{\circ}$ C)



Ambient Temperature (°C)



## **Typical Characteristic Curves – Radiation Pattern**

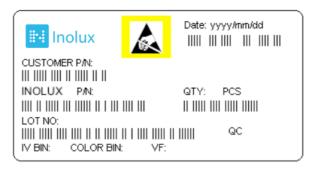


# **Ordering Information**

Product	Emission Color	Technology	Test Current I <sub>F</sub> (mA)	Radiant Intensity Ee (mW/sr) (Typ.)	Forward Voltage V <sub>F</sub> (V) (Typ.)	Orderable Part Number
INL-3ABCMIR40	Infrared	AlGaAs	20	10	1.3	INL-3ABCMIR40



## **Label Specifications**



### Inolux P/N:

I	N	L	-	3	Α	ВС	MIR	4	0	Х	Х	Х	Χ
		Pa		Package		Lens	Color	View Angle		Customized Stamp-off			
	Inolw mp Ty			stan	\ = dard nm	BC=Blue Clear	MIR = 880nm	40 =	40 deg.				

### Lot No.:

Z	2	0	1	7	01	24	001
Internal		Year (2017	2018 \	Month	Date	Serial	
Tracker		1Cai (2017)	, 2010,)	141011611	Date	Scriai	





## Reliability

Item	Frequency/ lots/ samples/ failures	Standards Reference	Conditions		
Precondition	For all reliability monitoring tests according to JEDEC Level 2	J-STD-020	<ul><li>1.) Baking at 85°C for 24hrs</li><li>2.) Moisture storage at 85°C/60% R.H. for 168hrs</li></ul>		
Solderability	1Q/ 1/ 22/ 0	JESD22-B102-B And CNS-5068	Accelerated aging 155°C/ 24hrs Tinning speed: 2.5+0.5cm/s Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s		
Resistance to soldering heat		CNS-5067	Dipping soldering terminal only Soldering bath temperature A: 260+/-5°C; 10+/-1s B: 350+/-10°C; 3+/-0.5s		
Operating life test	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs 85°C/ 60%R.H. for 168hrs 2.) Tamb25°C; IF=20mA; duration 1000hrs		
High humidity, high temperature bias	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C Humidity: 85% R.H., IF=5mA Duration: 1000hrs		
High temperature bias	1Q/ 1/ 20	IN specs.	Tamb: 55°C IF=20mA Duration: 1000hrs		
Pulse life test	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty cycle=0.125 (tp=125 μ s,T=1sec) Duration 500hrs)		
Temperature cycle	1Q/ 1/ 76/ 0	JESD-A104-A IEC 68-2-14, Nb	A cycle: -40 degree C 15min; +85 degree C 15min Thermal steady within 5 min 300 cycles 2 chamber/ Air-to-air type		
High humidity storage test	1Q/ 1/ 40/ 0	CNS-6117	60+3°C 90+5/-10% R.H. for 500hrs		
High temperature storage test	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs		
Low temperature storage test	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs		





### **Revision History**

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	01-19-2019
		_	

### **DISCLAIMER**

INOLUX reserves the right to make changes without further notice to any products herein to improve reliability, function or design. INOLUX does not assume any liability arising out of the application or use of any product or circuit described herein; neither does it convey any license under its patent rights, nor the rights of others.

### LIFE SUPPORT POLICY

INOLUX's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of INOLUX or INOLUX CORPORATION. As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

## **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Infrared Emitters category:

Click to view products by Inolux manufacturer:

Other Similar products are found below:

LTE-309 LTE-3279K LTE-4206C LTE-4208C EAILP03RDAA6 LTE-2871C LTE-4238 ASDL-4264-C22 OED-EL305F4C50-HT OP216-004 LTE-3376 EEL109 HL-PST-1608IR1C-L4 SFH 7016 IN-S126DSHIR IN-S126ETHIR IN-S42CTQHIR IN-S63FTHIR MHT153IRCT MHS153IRCT HIR204C/H0 HIR323C LTE-209 IR12-21C/TR8 IR17-21C/TR8 IR26-21C/L110/TR8 IR91-21C/TR10 KM-4457F3C L-53F3BT WP3A10F3C LTE-4208 IR42-21C/TR8 HSDL-4261 APA3010F3C-GX SE2460-140 OP266-905 OP280D LTE-2871 HIR8323/C16 KP-2012SF4C KPA-3010F3C L-7113SF6C HIR19-21C/L11/TR8 IR19-21C/TR8 IR11-21C/TR8 IR204/H60 L-34F3C L-34SF4C L-7104F3BT HIR204C